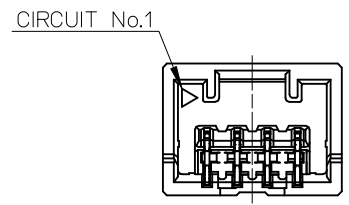
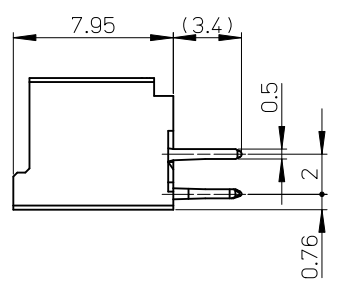
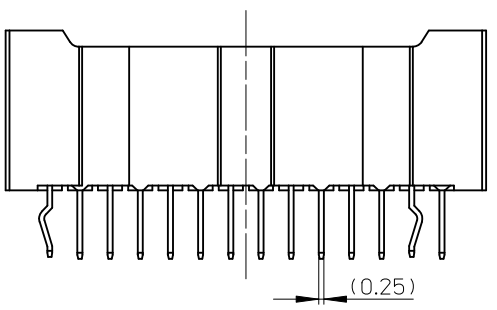
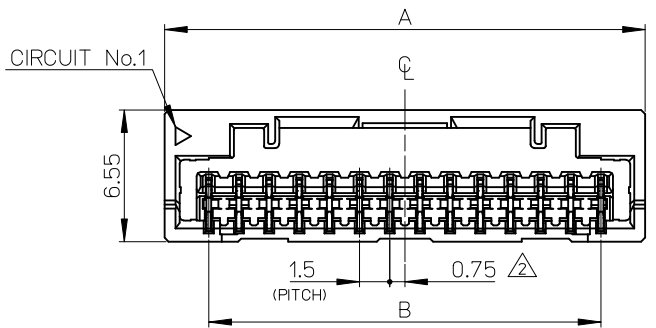
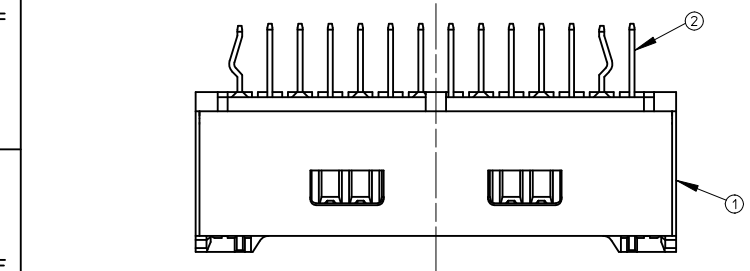
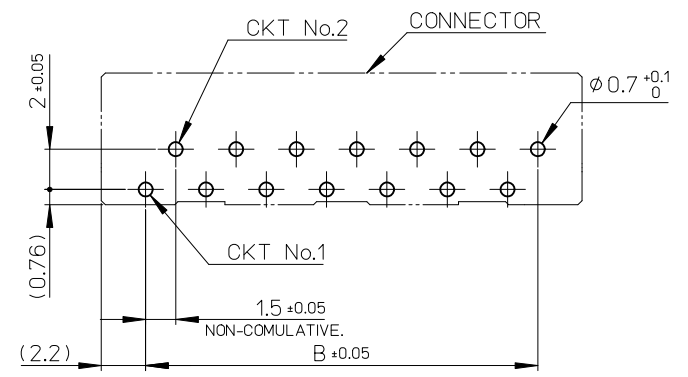


10 9 8 7 6 5 4 3 2 1



2~11極 CIRCUIT No.1
CIRCUIT No.1 OF 2-11 CIRCUIT

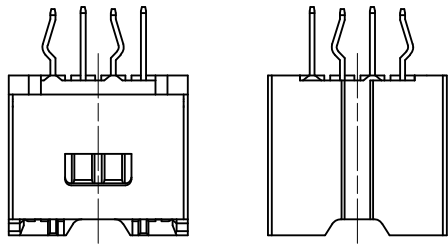


基板取付穴推奨寸法 (マウント面)
RECOMMENDED P.C.BOARD
HOLE DIMENSION
(MOUNTING SIDE)
(t=1.6)

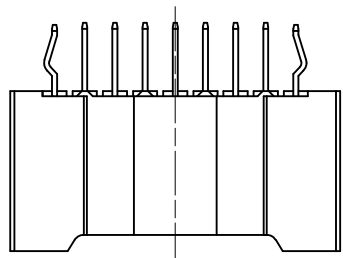
26.8	21	25.4	503159-15**	15
25.3	19.5	23.9	503159-14**	14
23.8	18	22.4	503159-13**	13
22.3	16.5	20.9	503159-12**	12
20.8	15	19.4	503159-11**	11
19.3	13.5	17.9	503159-10**	10
17.8	12	16.4	503159-09**	9
16.3	10.5	14.9	503159-08**	8
14.8	9	13.4	503159-07**	7
13.3	7.5	11.9	503159-06**	6
11.8	6	10.4	503159-05**	5
10.3	4.5	8.9	503159-04**	4
8.8	3	7.4	503159-03**	3
7.3	1.5	5.9	503159-02**	2
C	B	A	TRAY PACKAGE	CIRCUIT
				ORDER No.

No.	部品 PART	材料 MATERIAL
①	ハウジング HOUSING	ポリアミド (PA) UL94V-0 POLYAMIDE UL94V-0 色: 注記 5. 参照 COLOR: SEE NOTES 5.
②	ターミナル TERMINAL	銅合金 COPPER ALLOY 錫めっき (1.0 μm 以上) TIN PLATING OVERALL SURFACES (1.0 MICROMETER MINIMUM) 下地: ニッケルめっき (1.0 μm 以上) UNDER PLATE: NICKEL OVERALL (1.0 MICROMETER MINIMUM)

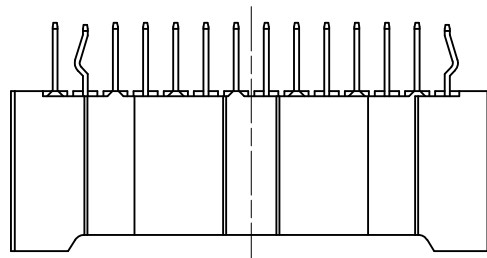
REVISED EC NO: J2012-0717 DRWN:THANYU CHKD:KASAKAWA APPR:YO ITO REV D	DESCRIPTION 2011/11/21 2011/11/21 2011/11/21	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY SKUROSE	DATE 2008/09/03	TITLE 1.5 W/B CONN. SINGLE DIP ST REC. ASS'Y 2-15CKT WITHOUT BOSS			
		10 OVER 30 UNDER	±0.25	CHECKED BY KASAKAWA	DATE 2008/09/03	MOLEX INCORPORATED DOCUMENT NO. SD-503159-002 SHEET NO. 1 OF 2			
		30 OVER	±0.3	APPROVED BY SICHIKAWA	DATE 2008/09/03				
		ANGULAR ±3°		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE TABLE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	



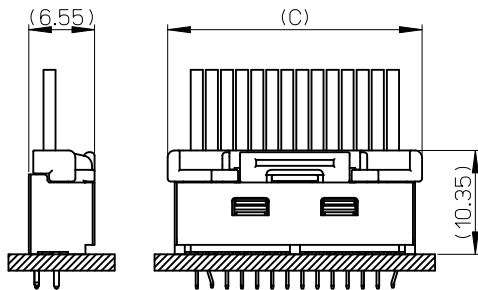
2~5 極形状 (ロック面及び反ロック面)
 FIGURE OF 2-5 CIRCUIT (LOOK SIDE AND UN-LOCK SIDE)



6~10 極形状 (反ロック面)
 FIGURE OF 6-10 CIRCUIT (UN-LOCK SIDE)



11~15 極形状 (反ロック面)
 FIGURE OF 11-15 CIRCUIT (UN-LOCK SIDE)



嵌合図 (SCALE 2:1)
 MATED CONNECTORS (SCALE 2:1)

NOTES

1. 嵌合相手 : 502578 シリーズ
 MATE WITH : 502578 SERIES.
2. 極数/2 = 偶数に適用
 APPLY FOR CIRCUIT SIZE/2=EVEN.
3. 端子テール部に錫めっきを使用している為、外観に摺動痕が付く場合があります。
 THE WOUND OF FRICTION MIGHT ADHERE TO EXTERNALS
 BECAUSE THE TIN PLATING IS USED FOR THE TAIL.

4. 製品番号
 MATERIAL No.
 503159-***

極数
 CIRCUIT SIZE

ボス、色
 BOSS, COLOR

ボス無し		CIRCUIT		No.	COLOR
02~15	1	0	ベージュ	BEIGE	
		1	黒	BLACK	
		2	赤	RED	
		3	黄	YELLOW	
		4	青	BLUE	
		5	桃	PINK	
		6	緑	GREEN	
		7	茶	BROWN	
		8	橙	ORANGE	
02	3	9	紫	VIOLET	
		1	灰	GRAY	
		3	蛍光黄	FLUORESCENCE YELLOW	
		4	水	PALE BLUE	
		6	黄緑	YELLOWISH GREEN	

5. 本製品のプラスチック部に黒点・白点等が確認される場合や色合いが異なる場合がありますが、製品性能に影響はありません。
 THERE IS NO INFLUENCE IN THE PRODUCT PERFORMANCE THOUGH THE BLACK AND WHITE SPOT ETC. MIGHT BE CONFIRMED TO THE PLASTIC PART OF THIS PRODUCT AND THE SHADE MIGHT BE DIFFERENT.
6. ELV及びRoHS 適合品
 ELV AND RoHS COMPLIANT
7. ボス有形状は“SD-503159-001”を参照願います。
 REFER TO “SD-503159-001” FOR WITH BOSS.

REVISED EC NO: J2012-0717 DRWN:THANYU CHKD:KASAKAWA APPR:YO ITO	DESCRIPTION 2011/11/21 2011/11/21 2011/11/21	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY SKUROSE	DATE 2008/09/03	TITLE 1.5 W/B CONN. SINGLE DIP ST REC. ASS'Y 2-15CKT WITHOUT BOSS			
		10 OVER 30 UNDER	±0.25	CHECKED BY KASAKAWA	DATE 2008/09/03	MOLEX MOLEX INCORPORATED DOCUMENT NO. SD-503159-002 SHEET NO. 2 OF 2			
		30 OVER	±0.3	APPROVED BY SICHIKAWA	DATE 2008/09/03				
ANGULAR ±3 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE TABLE		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			